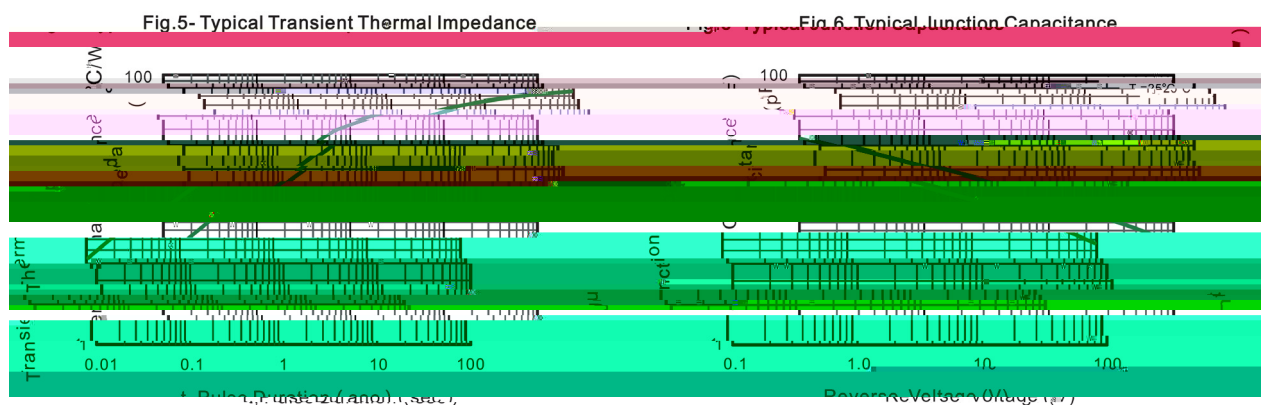
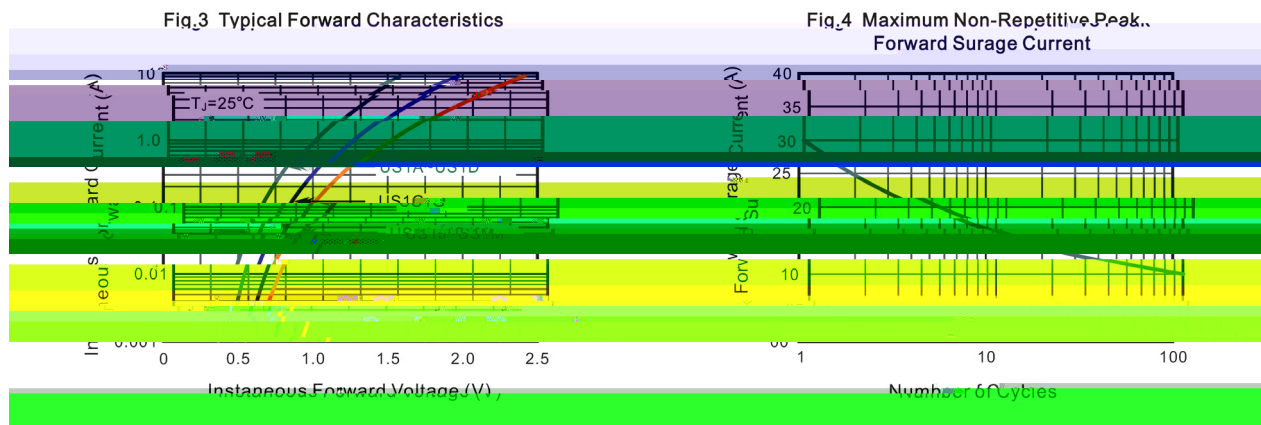
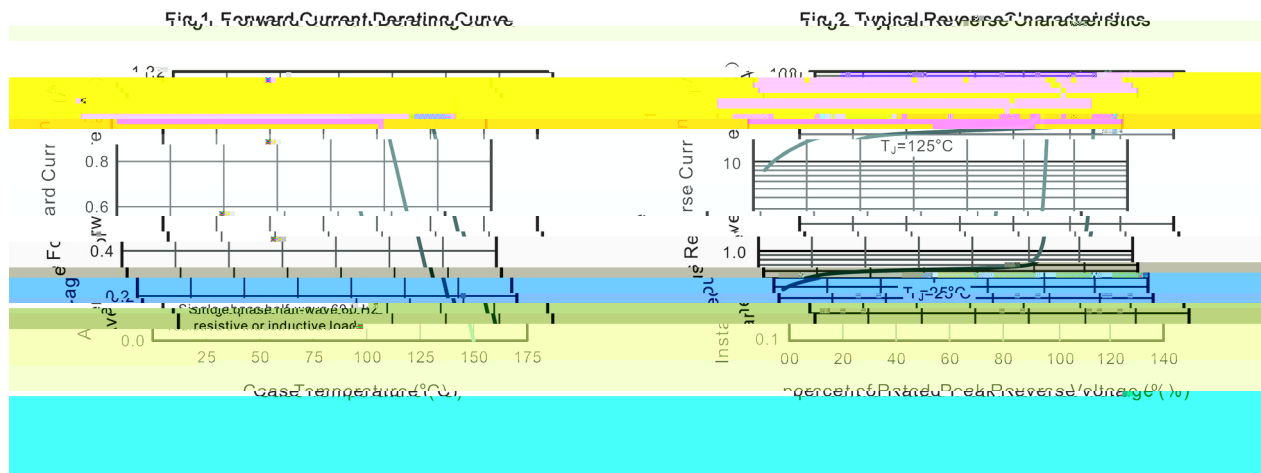


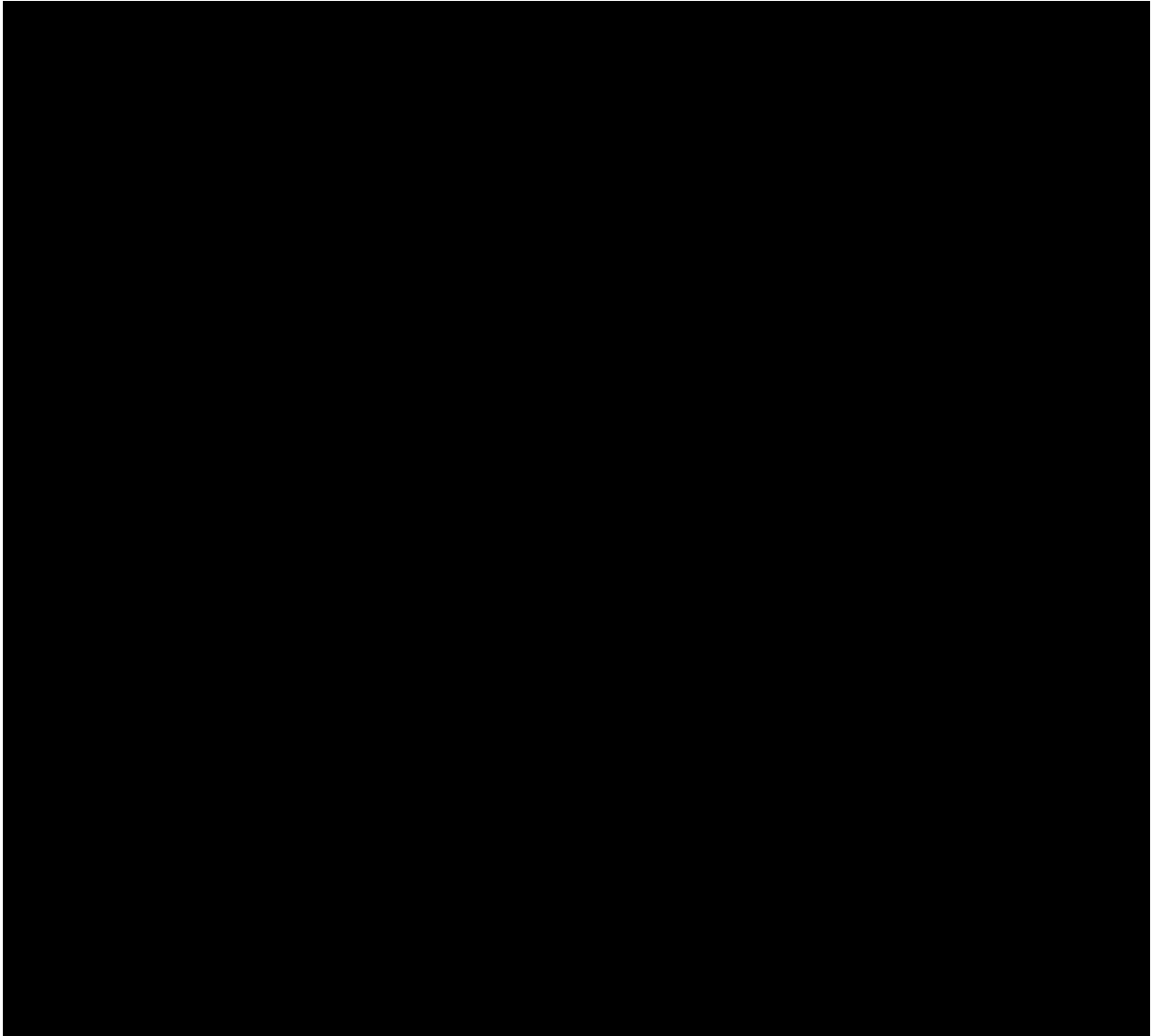
Note:

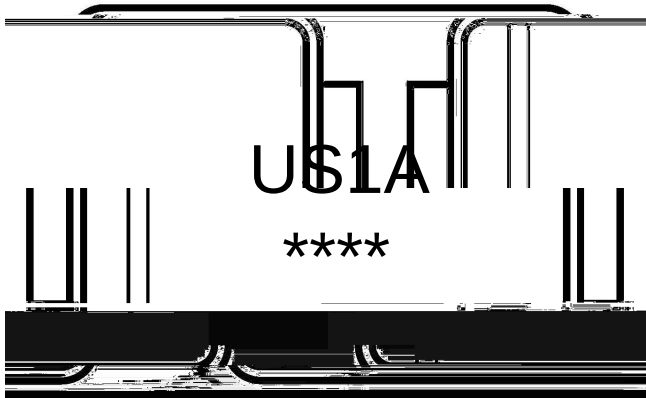
Parameter	Symbol	Rating								Unit
		US1A	US1B	US1D	US1G	US1J	US1K	US1M		

- (1) P.C.B. mounted with 2.0 X 2.0" (5 X 5 cm) copper pad areass.
- (2) Measured at 1 MHz and applied reverse voltage of 4 V D.C.

Parameter	Symbol	Test condition	Rating							Unit
			US1A	US1B	US1D	US1G	US1J	US1K	US1M	
Maximum Instantaneous	V _F	I _F =1.0A	1.0			1.3	1.65			V
Reverse Current at Maximum DC	I _R	T _a =25	5.0							uA
Maximum Reverse Recovery Time	T _{rr}	I _F =0.5A I _R =1.0A I _{rr} =0.25A	50			75			ns	





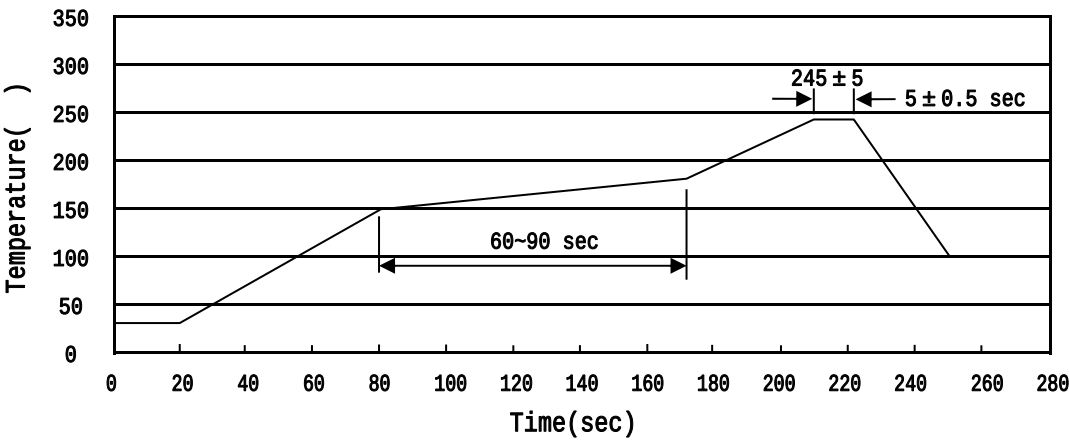


XV4D 7b
7b

Note:
XV4D Product Type Code
Lot No. Code, code change with Lot No

Type number	Marking code
US1A	US1A
US1B	US1B
US1D	US1D
US1G	US1G
US1J	US1J
US1K	US1K
US1M	US1M

Temperature Profile for IR Reflow Soldering(Pb-Free)



Note:

- 1

150 180

60 90sec;

1.Preheating:150~180 , Time:60~90sec.
- 2

245±5

5±0.5sec;

2.Peak Temp.:245±5 , Duration:5±0.5sec.
- 3

2 10 /sec.

3. Cooling Speed: 2~10 /sec.

260±5

10±1 sec.

Temp.:260±5

Time:10±1 sec

/ REEL

Package Type	Units					Dimension (unit mm ³)		
	Units/Reel	Reels/Inner Box	Units/Inner Box	Inner Boxes/Outer Box	Units/Outer Box	Reel	Inner Box	Outer Box
SMA	5,000	2	10,000	7	70,000	13 ×12	336×336×40	380×335×366